Zener Diode

DZ26051×0L

## **Panasonic**

### DZ26051×0L

### Silicon epitaxial planar type

For constant voltage / For surge absorption circuit DZ27051 in ML2 type package

#### ■ Features

- Excellent rising characteristics of zener current IZ
- · Low zener operating resistance RZ
- Halogen-free / RoHS compliant
   (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol : CJ or CU

#### ■ Packaging

Embossed type (Thermo-compression sealing) 10 000 pcs / reel (standard)

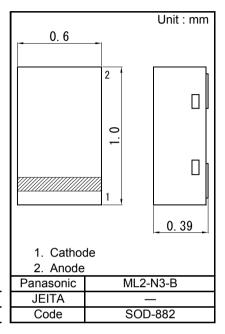
#### ■ Absolute Maximum Ratings Ta = 25 °C

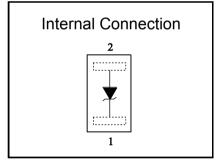
Parameter	Symbol	Rating	Unit
Repetitive peak forward current	IFRM	200	mA
Total power dissipation *1	PT	100	mW
Electrostatic discharge *2	ESD	±15	kV
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note) \*1 PT = 100 mW achieved with a printed circuit board.

\*2 Test method:IEC61000\_4\_2

( C = 150 pF , R = 330  $\Omega$  , Contact discharge : 10 times )





#### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	VF	IF = 10 mA			1.0	V
Zener voltage *1, *2	VZ	IZ = 5 mA	4.85		5.36	V
Zener operating resistance	RZ	IZ = 5 mA			60	Ω
Zener rise operating resistance	RZK	IZ = 1 mA			500	Ω
Reverse current	IR	VR = 2.0 V			1.0	μΑ
Temperature coefficient of zener voltage *3	SZ	IZ = 5 mA		0.7		mV/°C

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
  - 2. Absolute frequency of input and output is 5 MHz.
  - 3. \*1 The temperature must be controlled 25 °C for VZ mesurement. VZ value measured at other temperature must be adjusted to VZ ( 25 °C )
    - \*2 VZ guaranteed 20 ms after current flow.
    - \*3 Tj = 25 °C to 150 °C

#### Rank classification

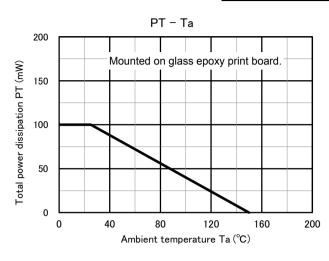
Code	M			0		
Rank	M			No-rank		
VZ	5.00	to	5.26	4.85	to	5.36
Marking symbol		CU			CJ	

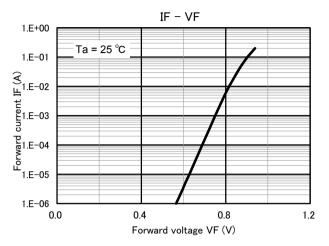
Established : 2013-04-03 Revised : 2017-01-10 **Panasonic** 

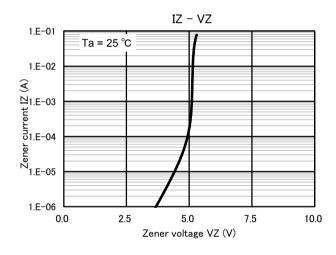
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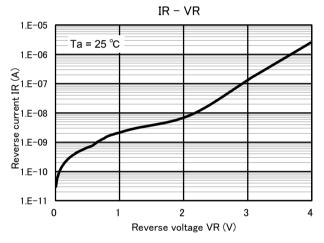
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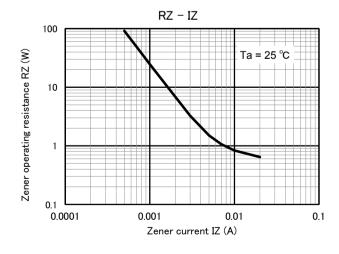
## Technical Data (reference)

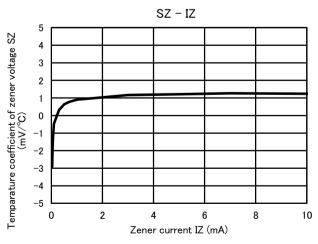










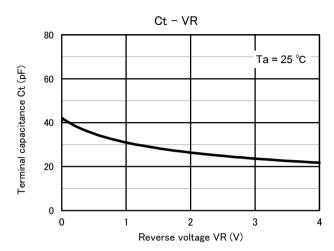


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## Technical Data (reference)



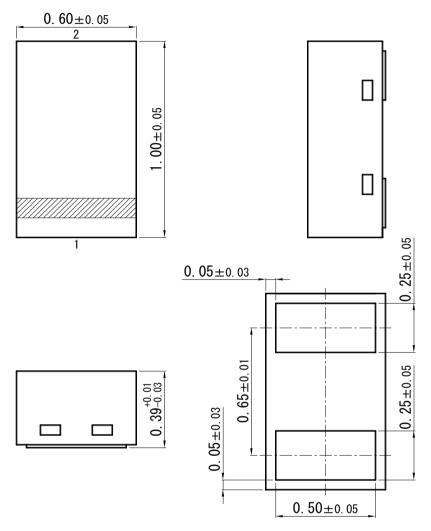
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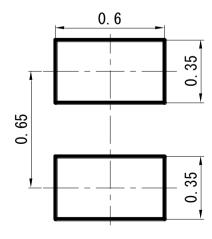
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ML2-N3-B Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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